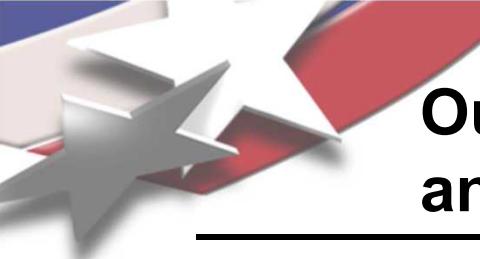


# Inducing and Imaging Localized Passivity Breakdown in Aluminum using an AFM Approach

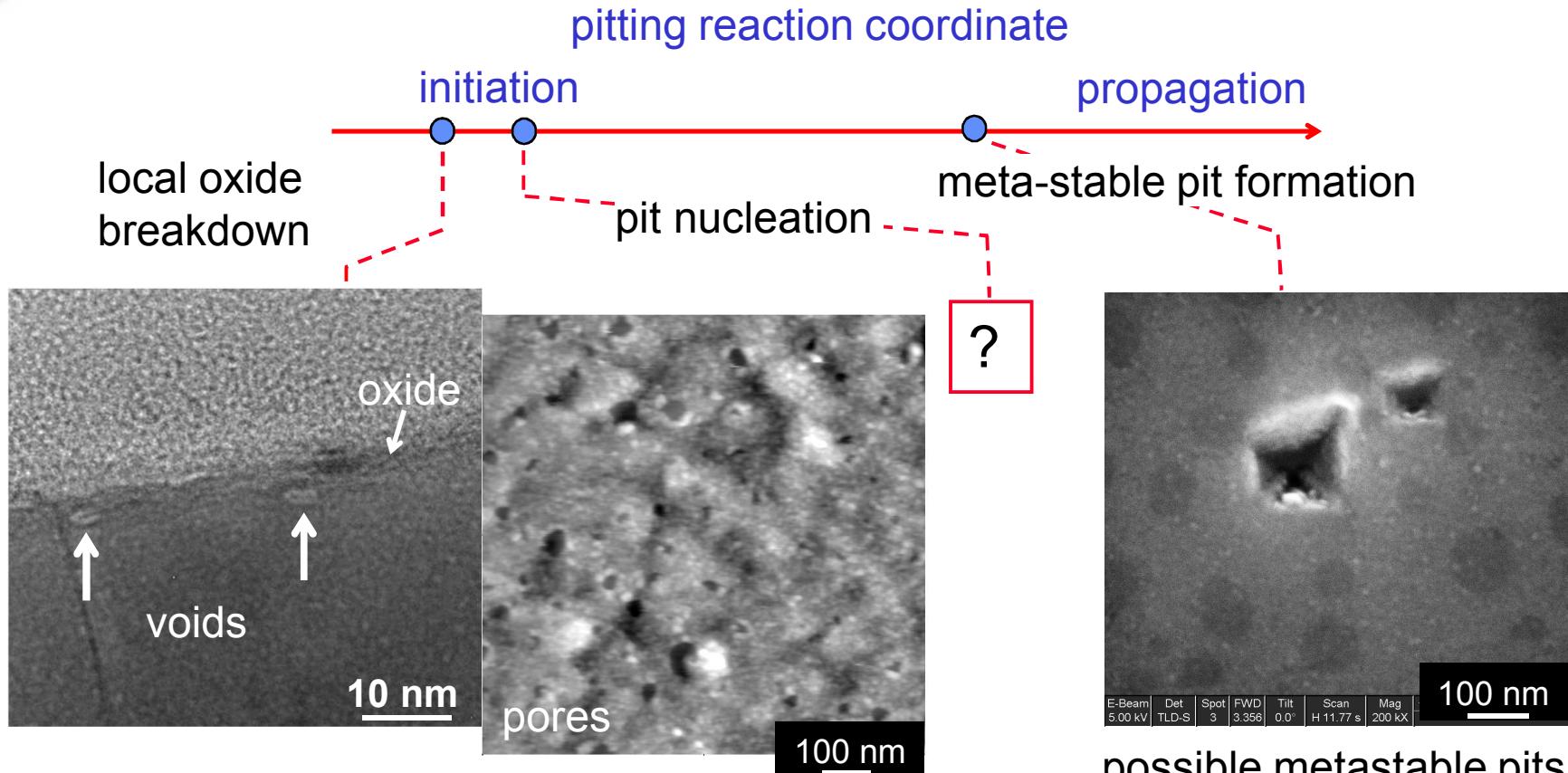
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DOE Basic Energy Sciences Office of Materials & Engineering Sciences

Sandia is a multiprogram laboratory operated by Sandia Corporation, a Lockheed Martin Company, for the U.S. Department of Energy's National Nuclear Security Administration under contract DE-AC04-94AL85000



# Our goal is to identify relevant nanostructure and establish causal links with pit initiation



Zavadil, *JES* 153 (8), B296 (2006)

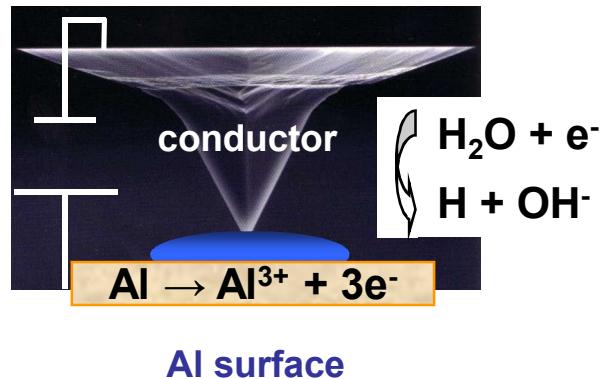
sufficient chemical and physical descriptions do not exist for these entities to support reliability models for high consequence applications of passive metals

# AFM-based approach for inducing local passivity loss

Building from the electrochemical machining field (Schuster & Ertl, Science 2000, Hudson)

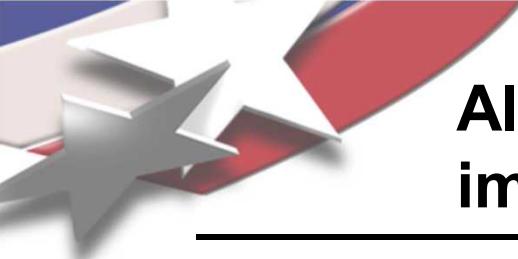
- point-and-polarize – short times localize field and constrain location  
μm resolution at  $10^1$  ns pulses widths
- local current density can be achieved to match metastable pit requirements ( $10^4$  A·cm $^{-2}$ )

Potential or current control



Proof of concept studies relax the time constraint – msec to sec pulse widths

Operate at 400 nm tip-surface separation



# Al thin films are used to facilitate AFM imaging

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## Type 1:

Al thin films electron beam deposited onto  $\text{SiO}_2:\text{Si}$

Nanocrystalline Al(111) textured films are formed - grain dia. 100 to 150 nm

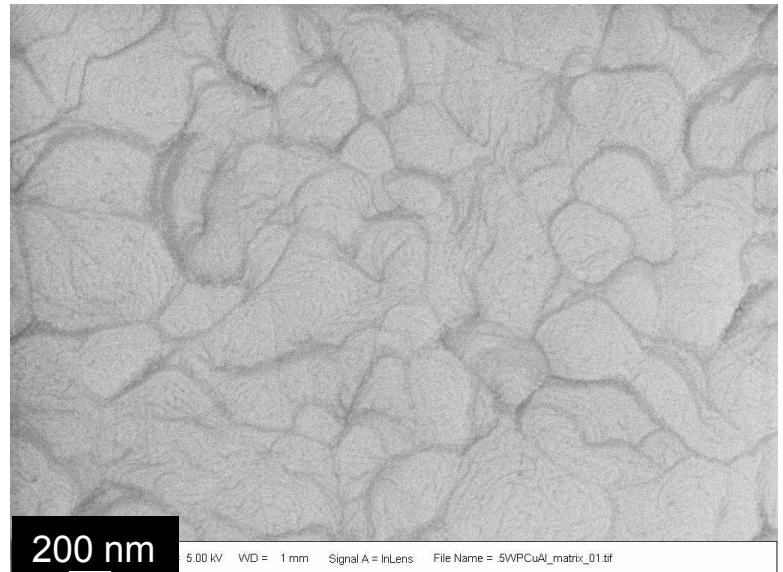
Anhydrous oxides  $\text{O}_2$  grown immediately after film deposition

## Type 2:

Al-0.5 wt% Cu thin films sputter deposited onto TiN:Ti layer on Si – CMOS interconnect technology

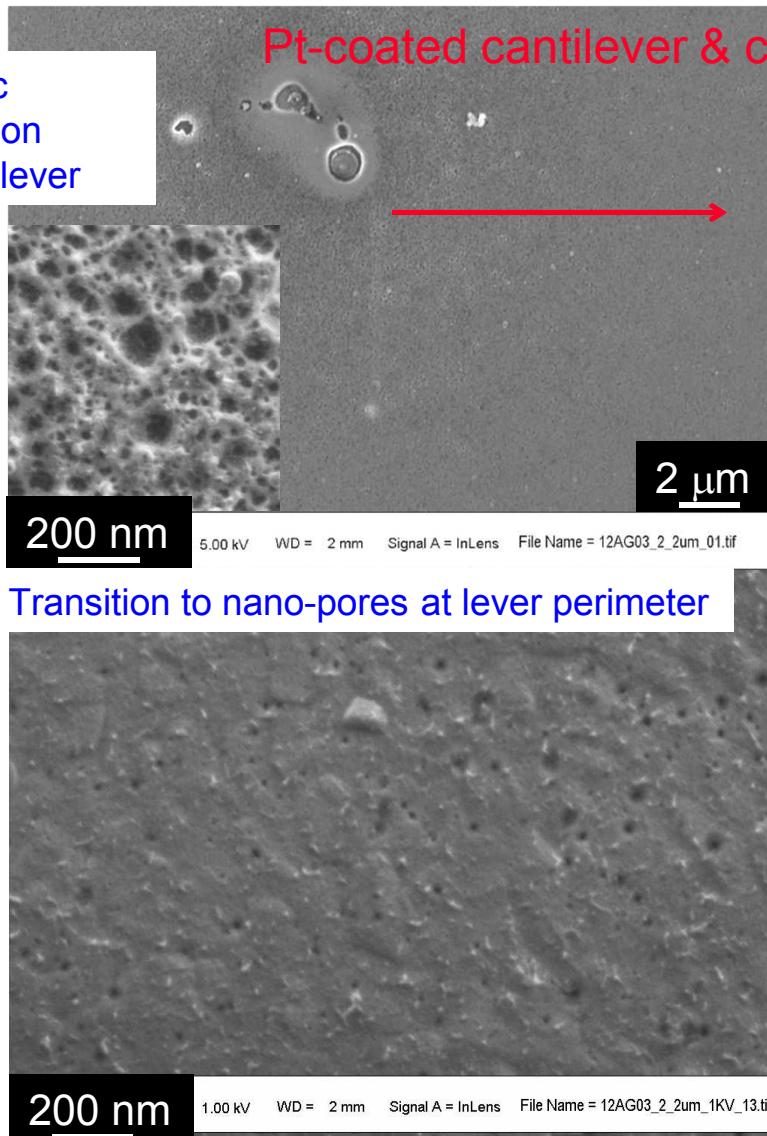
Al(111) texture films are formed - grain dia. 200 to > 500 nm

Air formed oxide at room temperature



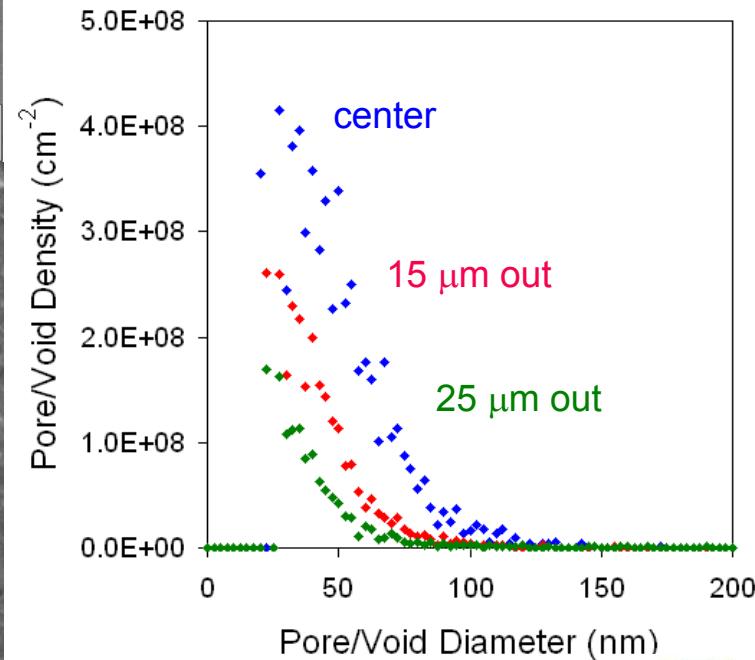
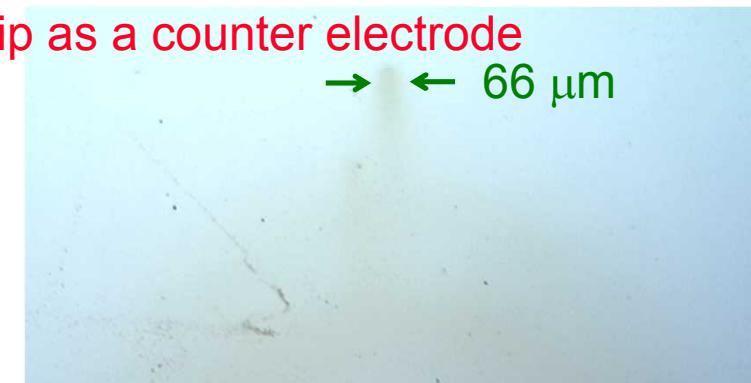
# Initial attempts focused on sweeping the potential of the lever & chip to evaluate localization

Anodic oxidation under lever



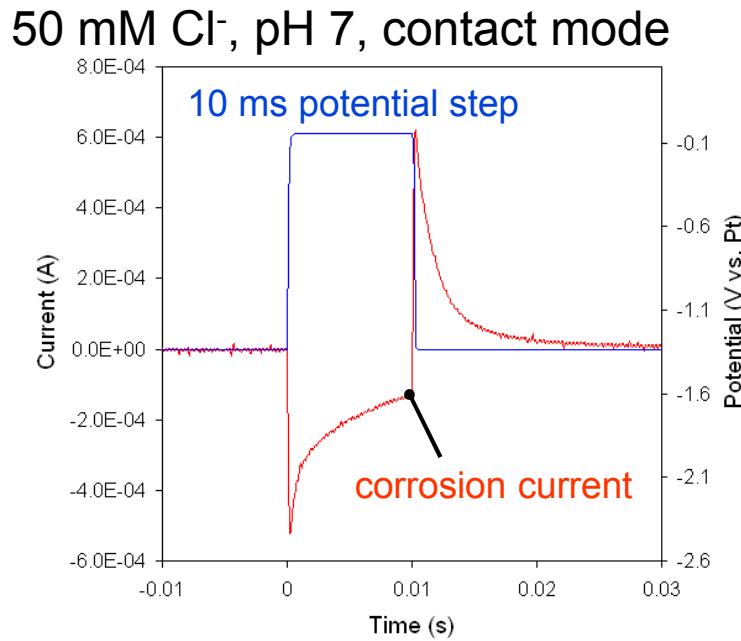
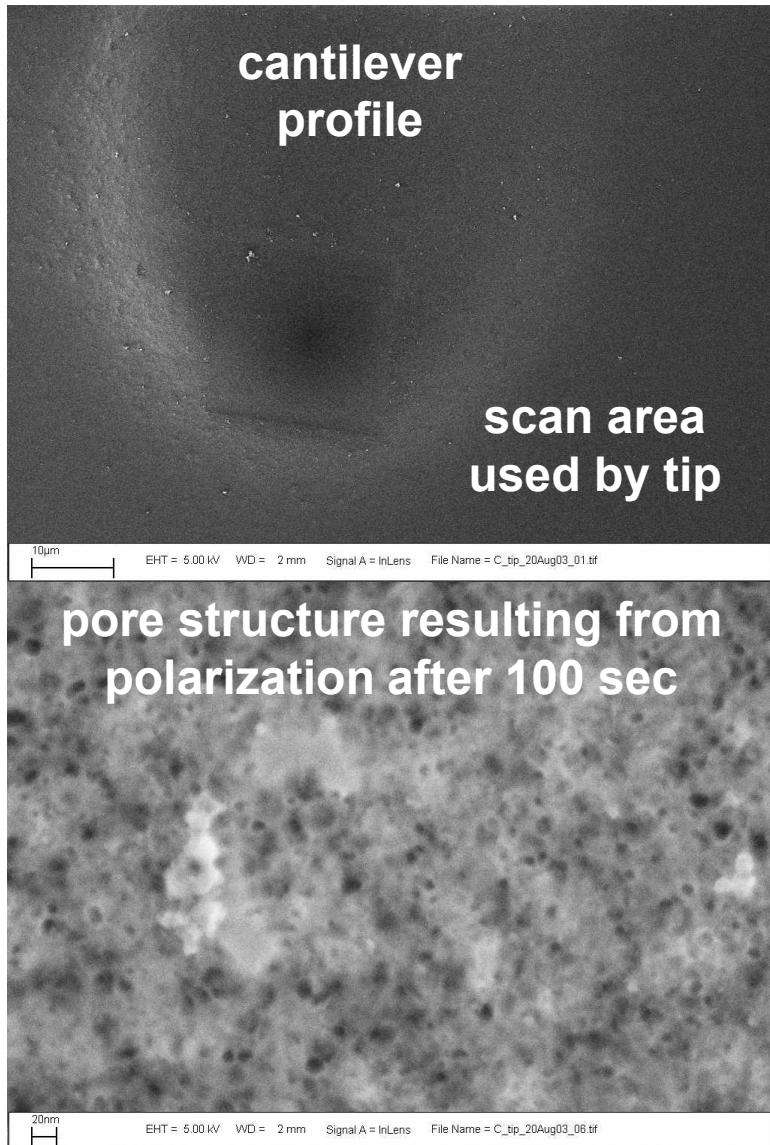
Pt-coated cantilever & chip as a counter electrode

→ ← 66  $\mu$ m



Sandia  
National  
Laboratories

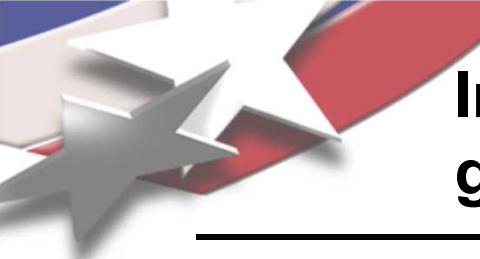
# Electrical insulation of the chip and holder assembly further improves localized response



Anodic activity can be localized to the tip and lever perimeter

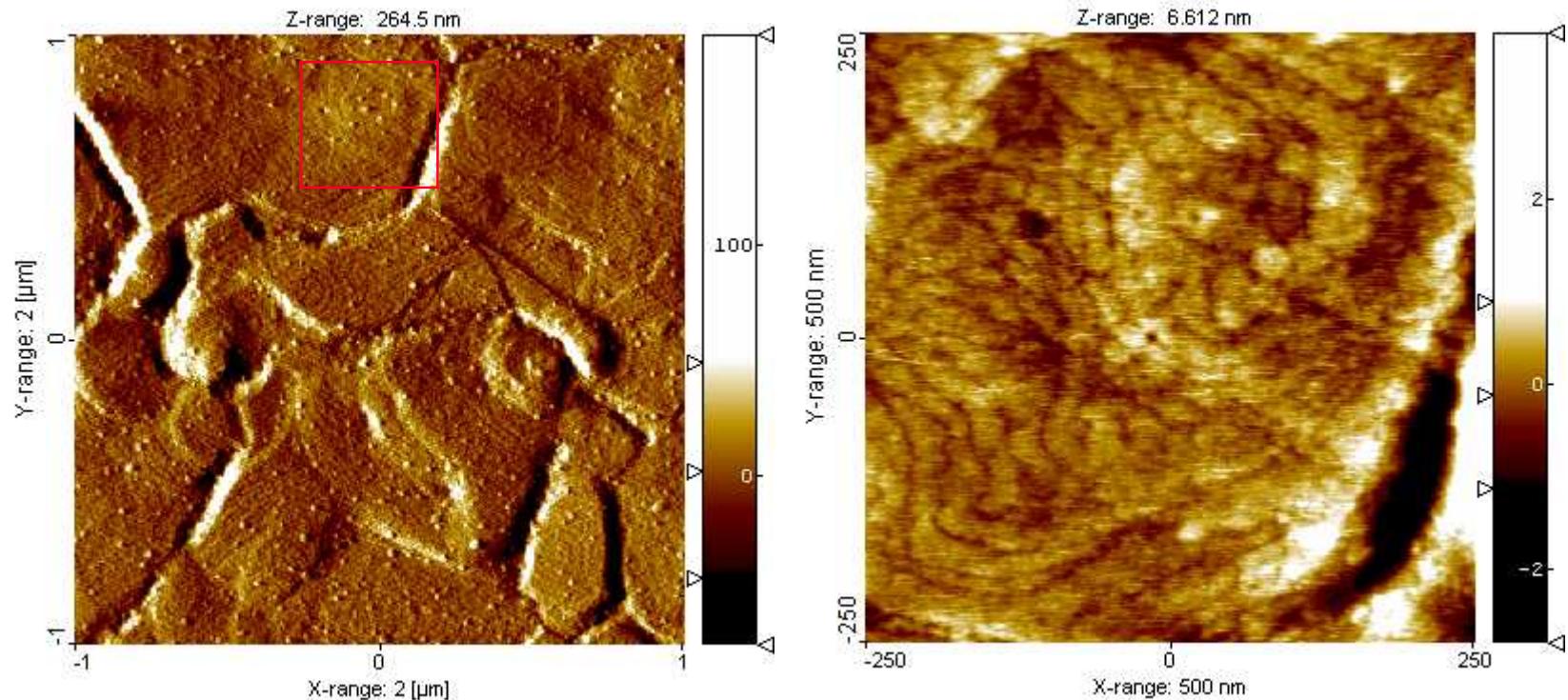
We do not drive pitting at 0V for pulse times up to 100 sec – consistent with void formation in this system

Limited by imaging mode and details of tip-surface interactions within this materials system



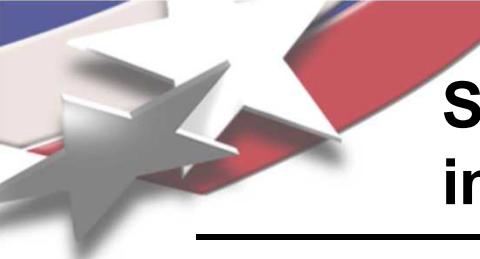
# Imaging fidelity improves markedly on going to AM-AFM in an attractive mode

hydrated Al - 0.5 wt% Cu film in 50 mM Cl<sup>-</sup>, pH5.9



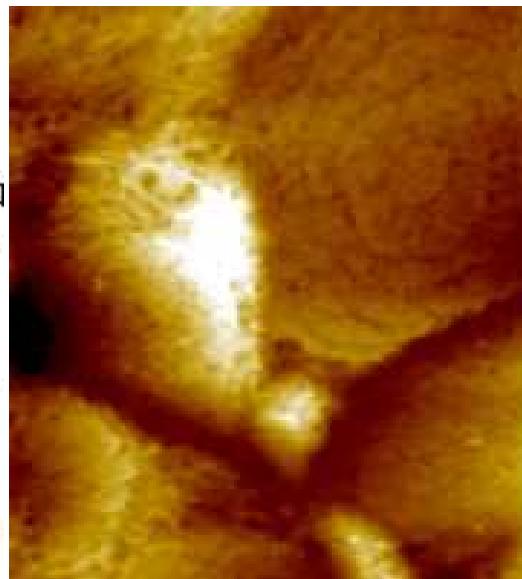
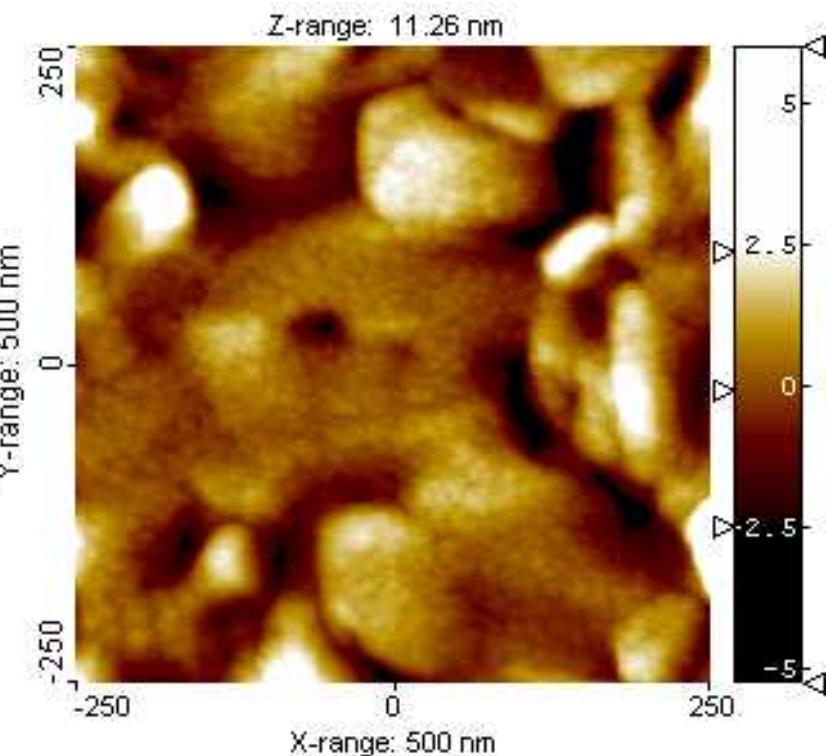
growth steps from the deposition process are evident

oxide platelets decorate the growth step edges

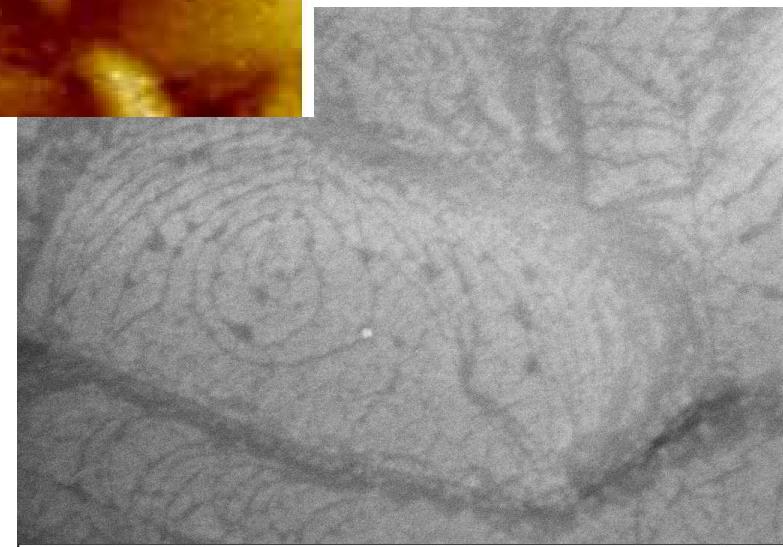


# Structure is consistent with previous imaging of dry and hydrated surfaces

Type 1 Al films

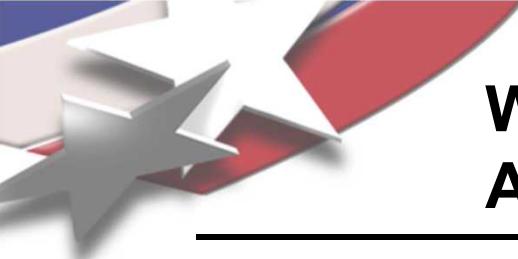


platelets with discontinuities



attractive mode imaging in  $\text{N}_2$  shows morphological structure to the oxide

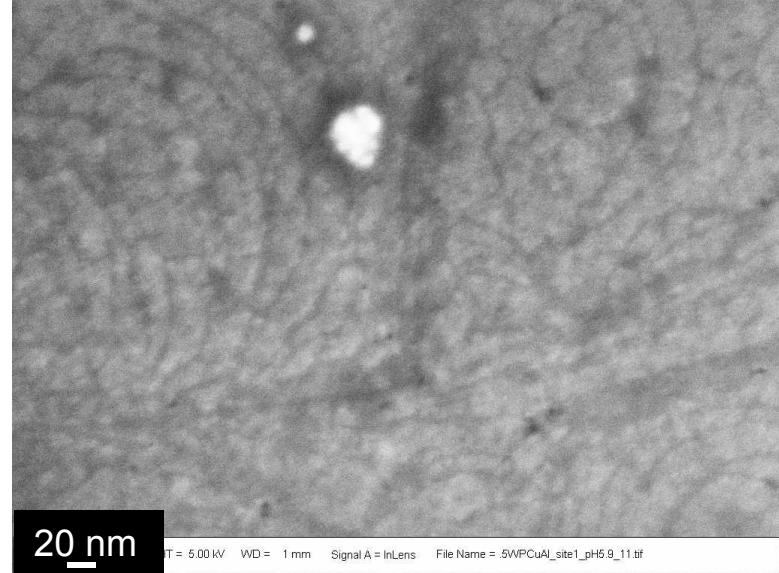
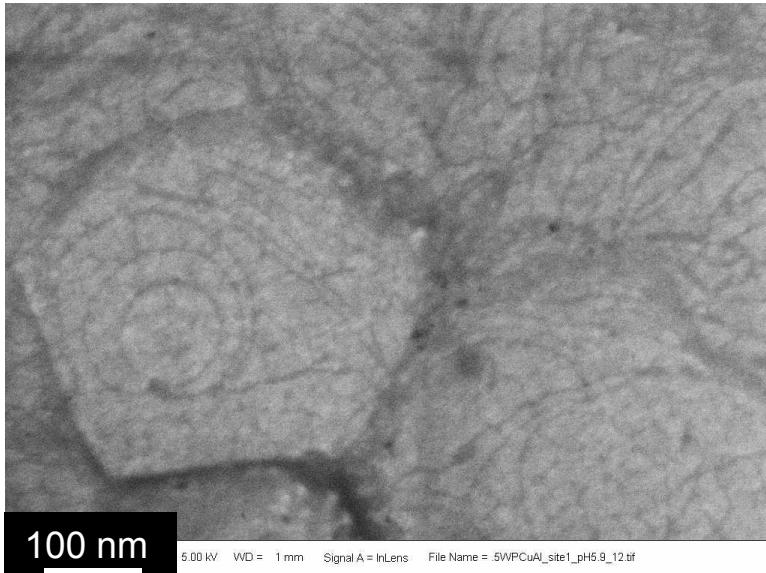
Type 2 Al-Cu films



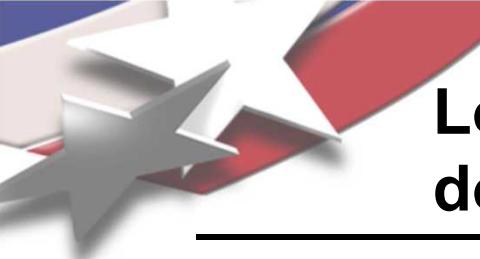
# We anticipate nanopores will form in the Al-0.5 wt% Cu system with polarization

Slow rate polarization of Al-0.5 wt% Cu in 50 mM Cl<sup>-</sup>, pH 5.9 at 167  $\mu\text{V}\cdot\text{s}^{-1}$

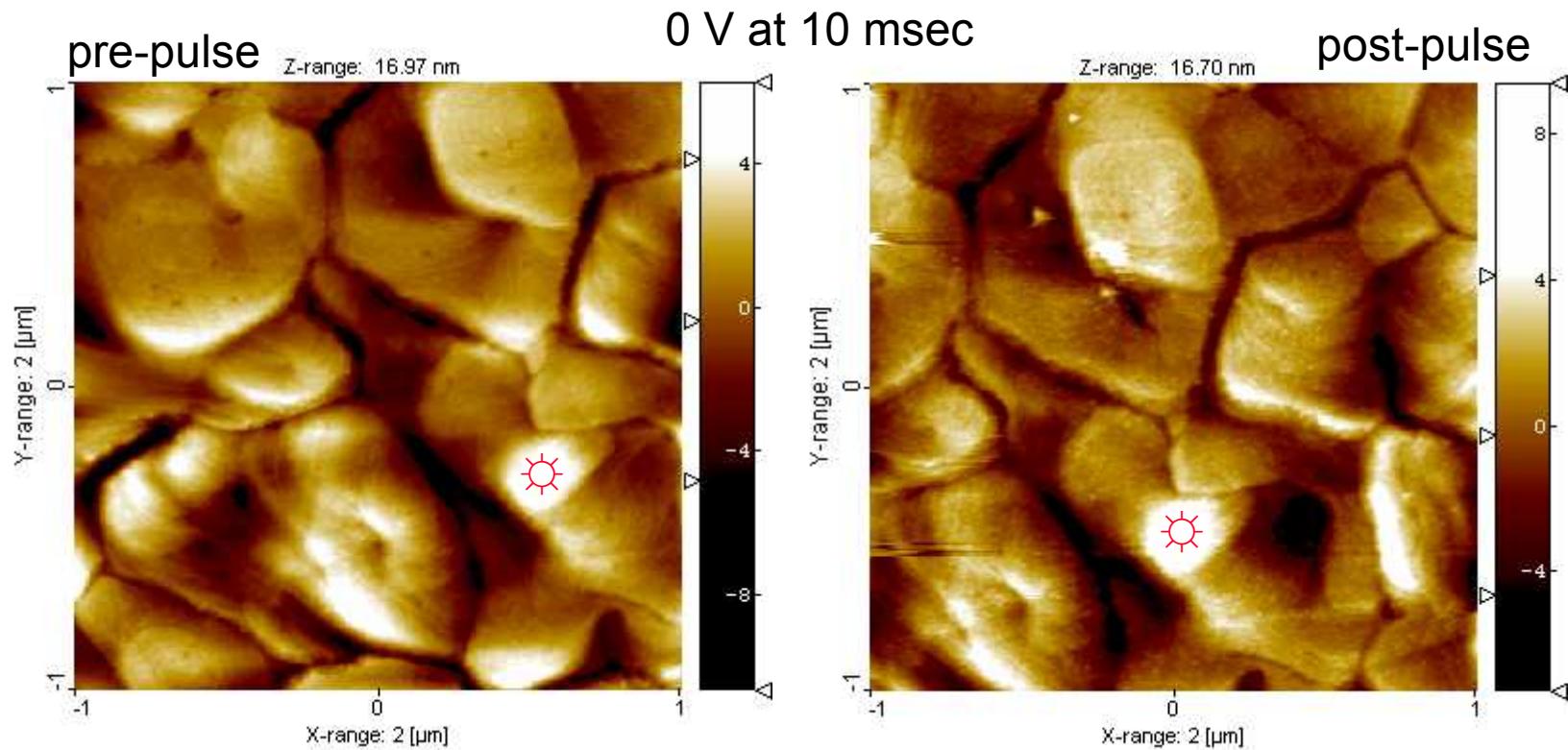
ex situ SEM



a fine pore structure appears at facet perimeters and grain boundaries



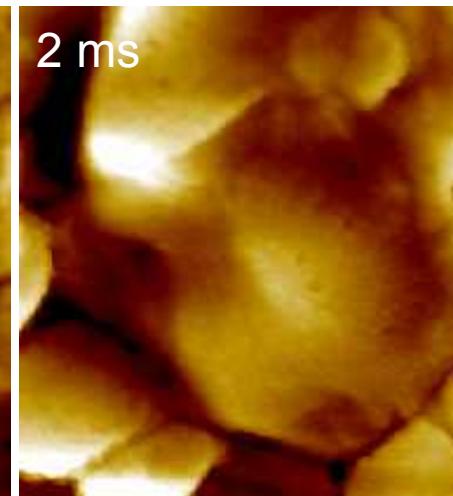
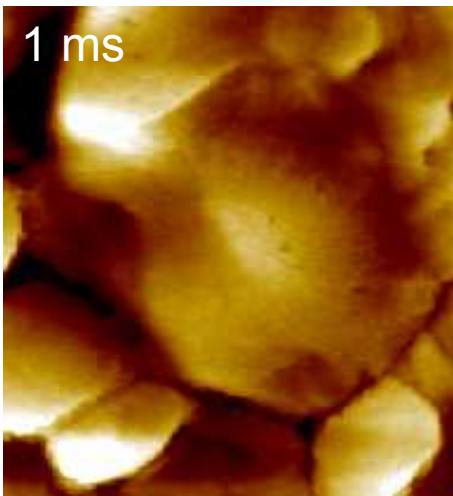
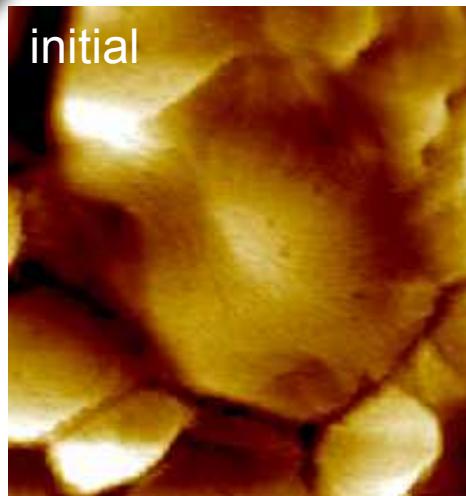
# Low applied cell potentials at short times do not produce discernable impacts



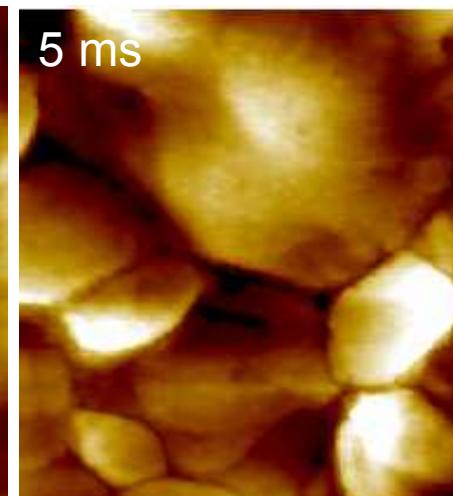
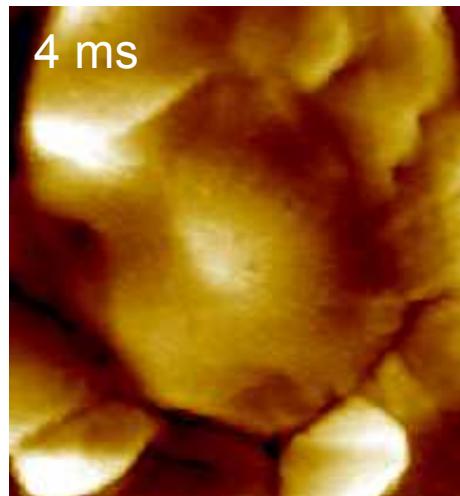
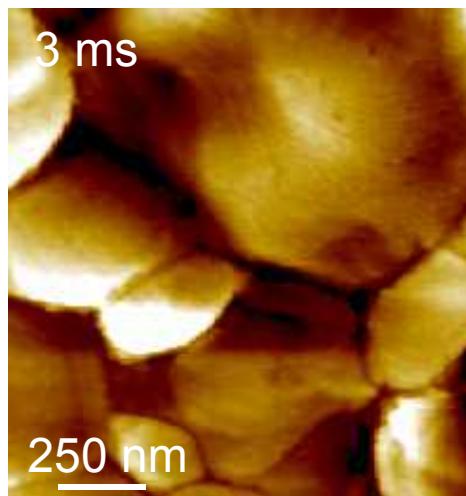
tip instabilities demonstrate the difficulty of keeping tip-surface interaction attractive



# Oxide platelet morphology is altered with repeated and longer potential pulses



1 V tip –  
sample  
potential  
pulse



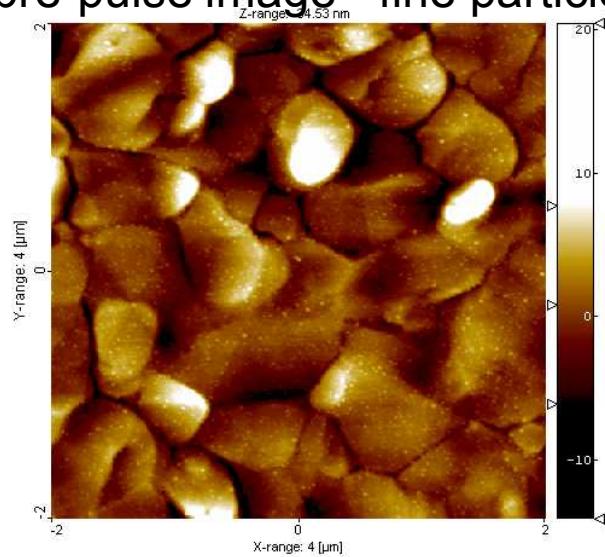
transition  
from aligned  
platelet along  
growth steps  
to a more  
nodular  
structure -  
induced  
oxide growth

250 nm

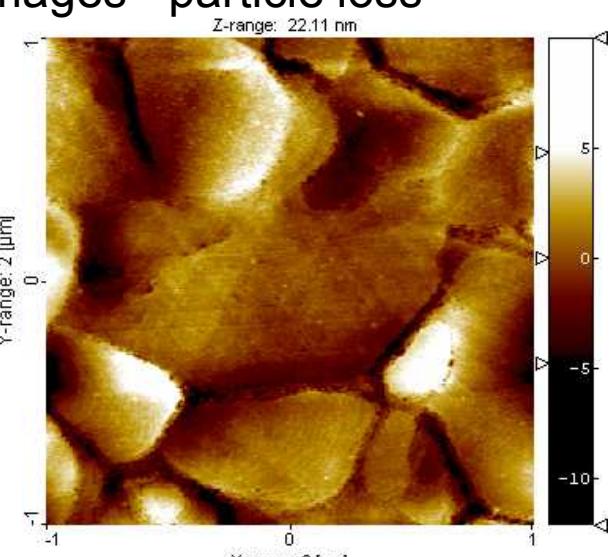
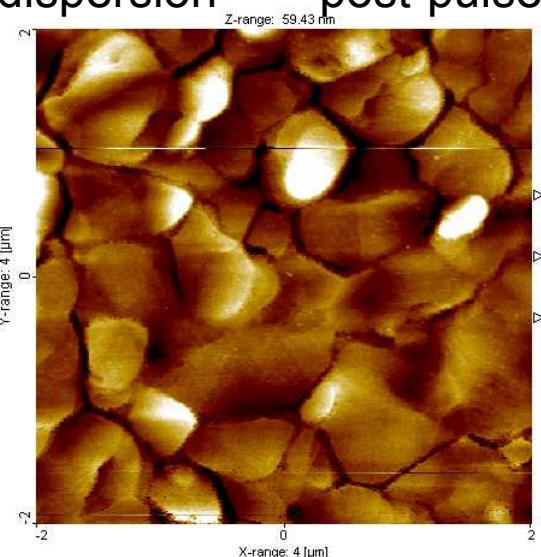
a specific degree of monitoring local site evolution appears possible

# Response to a 1V, 1 sec potential pulse

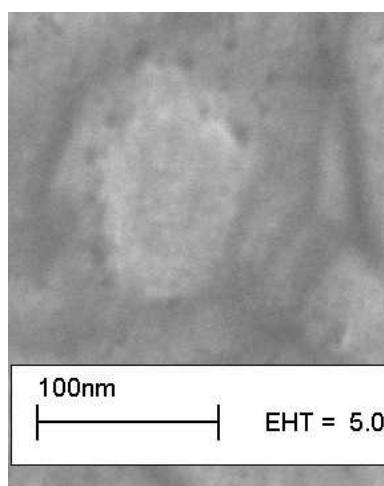
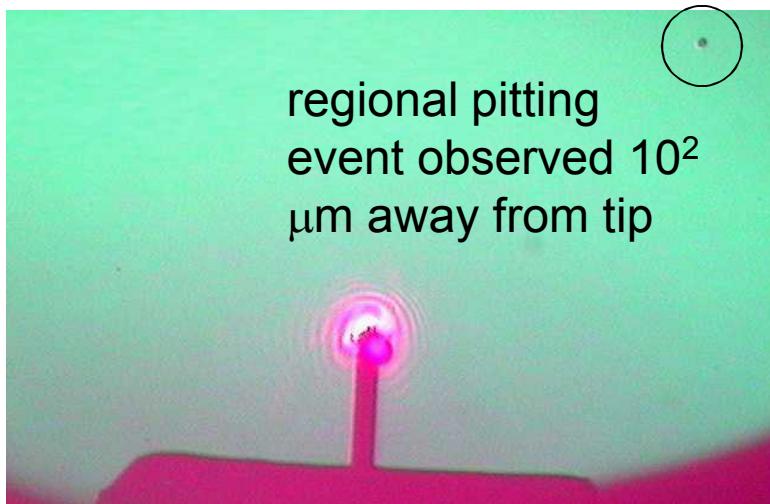
pre-pulse image - fine particle dispersion



post-pulse images - particle loss

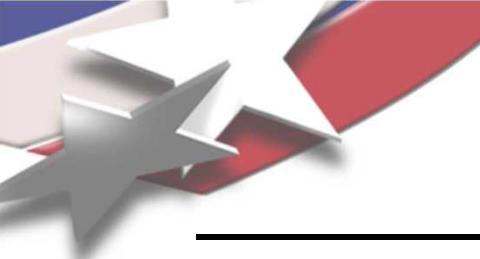


regional pitting  
event observed  $10^2$   
μm away from tip

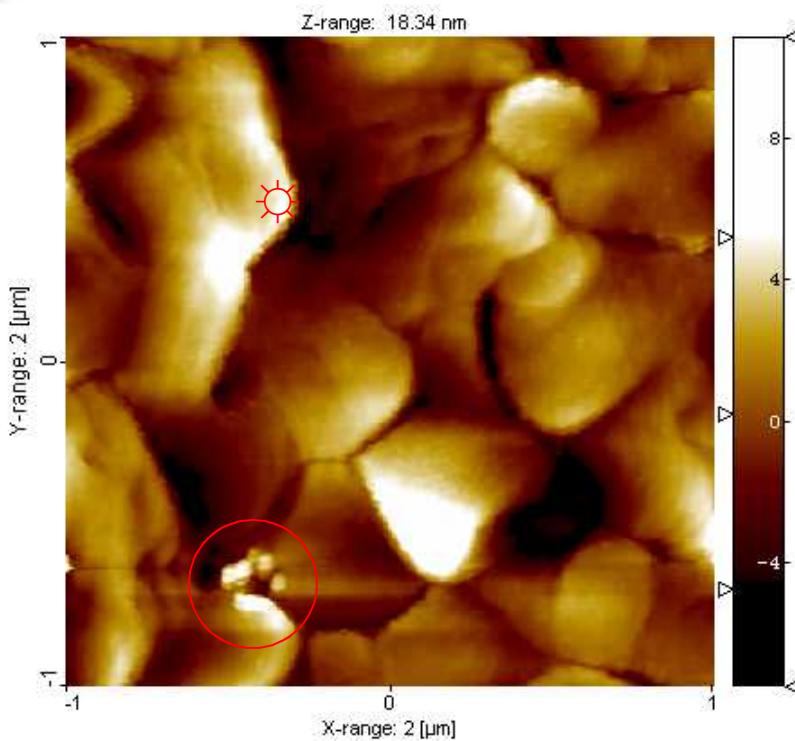


a fine pore structure  
appears at facet  
boundaries and edges

similar response to high  
rate current steps

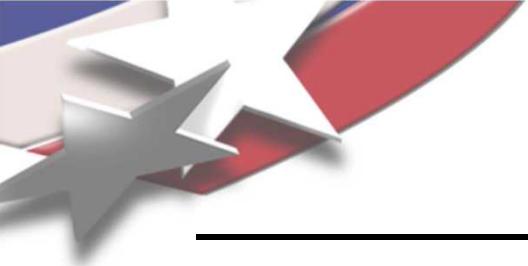


# Unintended tip-surface interactions create undesired effects



Excessive lever amplitude damping observed during a slow tip retraction from the surface –repulsive tip contact

Post 0 V, 1 msec pulse apparently drove the resulting pit



## Conclusions

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- *in situ* high fidelity imaging of the mechanically compliant passive oxide on aluminum is possible
  - operating in attractive mode AM-AFM is critical
- Localized anodic modification of the passive oxide is possible to monitor with *in situ* imaging
  - anodic dissolution confined to the lever region
  - nanopore formation at longer pulse times
- Current focus is to move toward higher frequency
  - currently capable of 14 nsec pulses
  - progressive sensitization of the oxide by potentiodynamic methods or repetitive pulsing